

## N-Channel Super Junction Power MOSFET $\,\,{\rm IV}$

#### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide ultra-low RDS(ON) and low gate charge and With a rapid recovery body diode.This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, industrial power applications,Fast charger, new energy vehicle charging pile, on-board OBC etc.

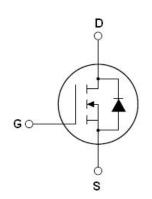
#### Features

- •New technology for high voltage device
- •Ultra low on-resistance and ultra low conduction losses
- ●Ultra Low Gate Charge cause lower driving requirements
- Diode reverse recovery speed is super fast
- High reliability
- ●ROHS compliant&Halogen Free

#### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- On-board charger(OBC)

# V<sub>DS min@Tjmax</sub> 710 V R<sub>DS(ON)TYP</sub> 110 mΩ ID 26 A Qg 41 nC



Schematic diagram

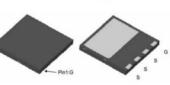
### ♦ Intrinsic fast-recovery body diode

DFN 8X8



| Device      | e Device Package Marking |             |
|-------------|--------------------------|-------------|
| NCE65NF130V | DFN8*8                   | NCE65NF130V |

#### Table 1. Absolute Maximum Ratings (T<sub>c</sub>=25℃)



Top View

Bottom View

| Parameter  | Symbol                  | Value   | Unit |
|--|-------------------------|---------|------|
| Drain-Source Voltage (VGs=0V)                                      | Vds                     | 650     | V    |
| Gate-Source Voltage (VDs=0V) AC (f>1 Hz)                           | Vgs                     | ±30     | V    |
| Gate-Source Voltage (VDs=0V) DC                                    | Vgs                     | ±20     | V    |
| Continuous Drain Current at Tc=25°C                                | I <sub>D (DC)</sub>     | 26      | A    |
| Continuous Drain Current at Tc=100°C                               | I <sub>D (DC)</sub>     | 18.2    | A    |
| Pulsed drain current <sup>(Note 1)</sup>                           | I <sub>DM (pluse)</sub> | 78      | A    |
| Maximum Power Dissipation(Tc=25℃)                                  | PD                      | 237     | W    |
| Derate above 25°C  |                         | 1.58    | W/°C |
| Avalanche current <sup>(Note 1)</sup>                              | I <sub>AS</sub>         | 7       | A    |
| Drain Source voltage slope, V_Ds $\leq$ 480 V,                     | dv/dt                   | 50      | V/ns |
| Reverse diode dv/dt, $V_{DS} \leqslant 480 \text{ V},I_{SD} < I_D$ | dv/dt                   | 50      | V/ns |
| Operating Junction and Storage Temperature Range                   | TJ,TSTG                 | -55+175 | °C   |

\* limited by maximum junction temperature



#### Table 2. Thermal Characteristic

| Parameter   | Symbol            | Value | Unit  |
|---|-------------------|-------|-------|
| Thermal Resistance, Junction-to-Case (Maximum)    | R <sub>thJC</sub> | 0.63  | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R <sub>thJA</sub> | 62    | °C /W |

#### Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter                                 | Symbol              | Condition   | Min | Тур   | Max  | Unit |
|---|---------------------|---|-----|-------|------|------|
| On/off states                             |                     |   |     | 1     |      |      |
| Drain-Source Breakdown Voltage            | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250uA               | 650 |       |      | V    |
| Zero Gate Voltage Drain Current(Tc=25°C)  | I <sub>DSS</sub>    | V <sub>DS</sub> =650V,V <sub>GS</sub> =0V               |     |       | 10   | μA   |
| Zero Gate Voltage Drain Current(Tc=125°C) | I <sub>DSS</sub>    | V <sub>DS</sub> =650V,V <sub>GS</sub> =0V               |     |       | 400  | μA   |
| Gate-Body Leakage Current                 | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V               |     |       | ±100 | nA   |
| Gate Threshold Voltage                    | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =500uA | 3.5 | 4.2   | 5.0  | V    |
| Drain-Source On-State Resistance          | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =13A               |     | 110   | 130  | mΩ   |
| Dynamic Characteristics                   |                     |   | ·   |       |      |      |
| Input Capacitance                         | Clss                | N/ 50/11/ 01/   |     | 2161  |      | pF   |
| Output Capacitance                        | Coss                | V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,               |     | 95    |      | pF   |
| Reverse Transfer Capacitance              | C <sub>rss</sub>    | F=1.0MHz  |     | 50    |      | pF   |
| Total Gate Charge                         | Qg                  |   |     | 41.2  |      | nC   |
| Gate-Source Charge                        | Q <sub>gs</sub>     | V <sub>DS</sub> =480V,I <sub>D</sub> =13A,              |     | 16.3  |      | nC   |
| Gate-Drain Charge                         | Q <sub>gd</sub>     | V <sub>GS</sub> =10V                                    |     | 12.8  |      | nC   |
| Gate plateau voltage                      | Vgp                 |   |     | 7.0   |      | V    |
| Intrinsic gate resistance                 | R <sub>G</sub>      | f = 1 MHz open drain                                    |     | 1.5   |      | Ω    |
| Switching times                           |                     |   |     |       |      |      |
| Turn-on Delay Time                        | t <sub>d(on)</sub>  |   |     | 43    |      | nS   |
| Turn-on Rise Time                         | tr                  | V <sub>DD</sub> =380V,I <sub>D</sub> =13A,              |     | 16    |      | nS   |
| Turn-Off Delay Time                       | t <sub>d(off)</sub> | R <sub>G</sub> =1.7Ω,V <sub>GS</sub> =10V               |     | 93    |      | nS   |
| Turn-Off Fall Time                        | tf                  |   |     | 20    |      | nS   |
| Source- Drain Diode Characteristics       | ·                   |   | •   |       |      |      |
| Source-drain current(Body Diode)          | I <sub>SD</sub>     | T -05°O   |     |       | 26   | А    |
| Pulsed Source-drain current(Body Diode)   | Isdm                | - T <sub>c</sub> =25°C                                  |     |       | 78   | А    |
| Forward On Voltage                        | Vsd                 | Tj=25°C,I <sub>SD</sub> =26A,V <sub>GS</sub> =0V        |     | 1.0   | 1.2  | V    |
| Reverse Recovery Time                     | trr                 | Tj=25°C,I⊧=13A,di/dt=100A/µs                            |     | 145   |      | nS   |
| Reverse Recovery Charge                   | Qrr                 |   |     | 0.725 |      | uC   |
| Peak Reverse Recovery Current             | Irrm                |   |     | 10    |      | А    |

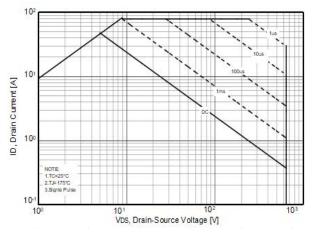
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

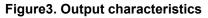
2. Tj=25  $^\circ\!\mathrm{C}$  ,VDD=50V,VG=10V, R\_G=25 $\Omega$ 

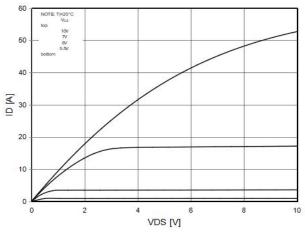


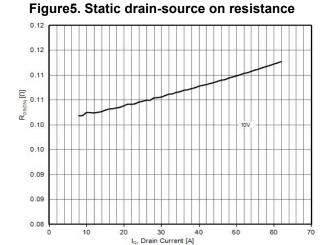
#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

#### Figure1. Safe operating area









#### Figure2. Capacitance

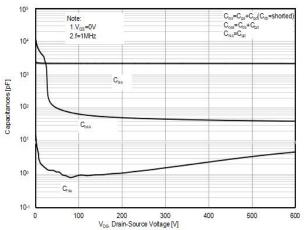
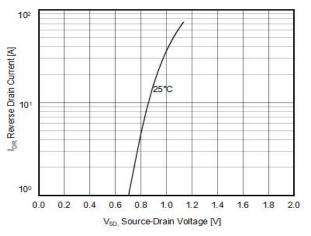


Figure4. Source-Drain Diode Forward Voltage



#### Figure6. Transfer characteristics

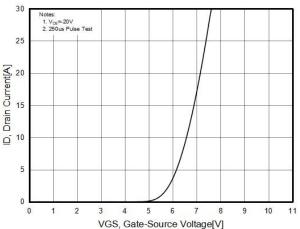




Figure7. R<sub>DS(ON)</sub> vs Junction Temperature

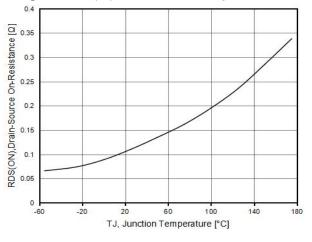


Figure9. Gate charge waveforms

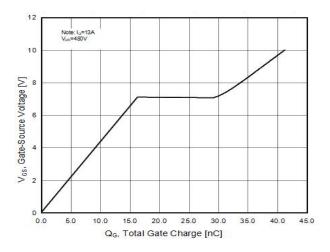


Figure8. BV<sub>DSS</sub> vs Junction Temperature

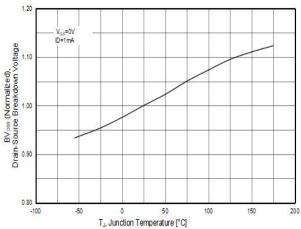
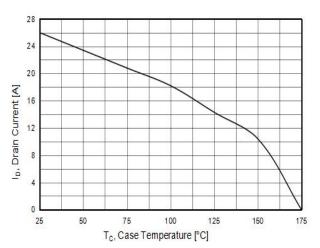


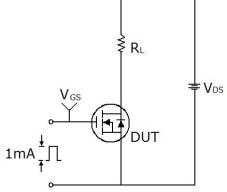
Figure10. Maximum I<sub>D</sub> vs Junction Temperature

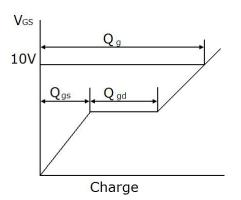




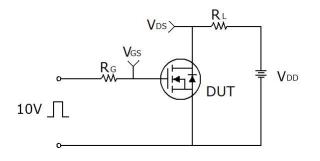
## Test circuit

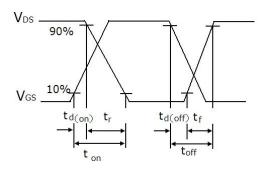
1) Gate charge test circuit & Waveform



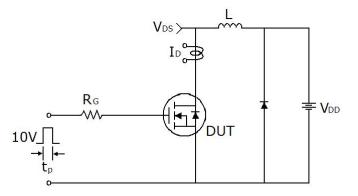


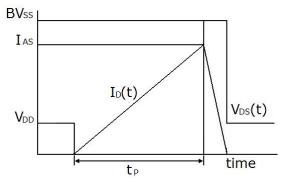
2) Switch Time Test Circuit:





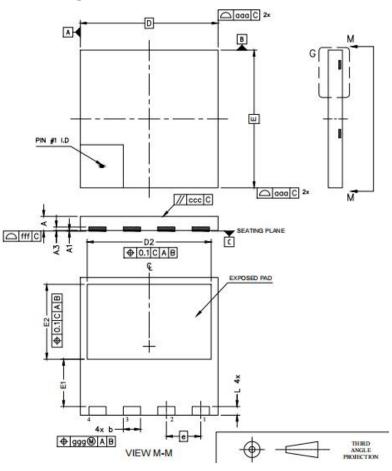
3) Unclamped Inductive Switching Test Circuit & Waveforms







## DFN8\*8 (B) Package Information



| Symbol | Dimensions In Millimeters |      | Dimensions In Inches |       |  |
|--------|---------------------------|------|----------------------|-------|--|
|        | Min.                      | Max. | Min.                 | Max.  |  |
| А      | 0.75                      | 0.95 | 0.030                | 0.037 |  |
| A1     | 0.00                      | 0.05 | 0.000                | 0.002 |  |
| b      | 0.90                      | 1.10 | 0.035                | 0.043 |  |
| A3     | 0.10                      | 0.30 | 0.004                | 0.012 |  |
| D      | 7.90                      | 8.10 | 0.311                | 0.319 |  |
| E      | 7.90                      | 8.10 | 0.311                | 0.319 |  |
| D2     | 7.10                      | 7.30 | 0.280                | 0.287 |  |
| E1     | 2.65                      | 2.85 | 0.104                | 0.112 |  |
| E2     | 4.25                      | 4.45 | 0.167                | 0.175 |  |
| е      | 2.00 BSC                  |      | 0.079 E              | 3SC   |  |
| L      | 0.40                      | 0.60 | 0.016                | 0.024 |  |



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